

Description

The VSM3401AY uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

General Features

• $V_{DS} = -30V, I_{D} = -4.4A$

 $R_{DS(ON)}$ < $80m\Omega$ @ V_{GS} =-2.5V

 $R_{DS(ON)}$ < 65m Ω @ V_{GS} =-4.5V

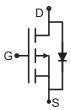
 $R_{DS(ON)}$ < $52m\Omega$ @ V_{GS} =-10V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- PWM applications
- Load switch
- Power management





SOT-23-3

Schematic Diagram

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM3401AY-S2	VSM3401AY	SOT-23-3	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	-30	V	
Gate-Source Voltage	V _G S	±12	V	
Drain Current-Continuous	I _D	-4.4	Α	
Drain Current-Pulsed (Note 1)	I _{DM}	-30	Α	
Maximum Power Dissipation	P _D	1.3	W	
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note 2)	$R_{\theta JA}$	95	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit			
Off Characteristics									
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-30	-33	-	V			



Parameter	Symbol	Condition	Min	Тур	Max	Unit			
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-24V,V _{GS} =0V	-	-	-1	μΑ			
Gate-Body Leakage Current	I _{GSS} V _{GS} =±12V,V _{DS} =0V		-	-	±100	nA			
On Characteristics (Note 3)									
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =-250μA	-0.7	-1	-1.3	V			
		V _{GS} =-10V, I _D =-4.2A	ı	39	52	mΩ			
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-4A	-	46	65	mΩ			
		V _{GS} =-2.5V, I _D =-1A		61	80	mΩ			
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-2A	-	10	-	S			
Dynamic Characteristics (Note4)									
Input Capacitance	C _{lss}	V _{DS} =-15V,V _{GS} =0V.	-	950	-	PF			
Output Capacitance	C _{oss}	V _{DS} =-15V,V _{GS} =UV, F=1.0MHz	-	115	-	PF			
Reverse Transfer Capacitance	C _{rss}	F-1.UIVITIZ	-	75	-	PF			
Switching Characteristics (Note 4)	Switching Characteristics (Note 4)								
Turn-on Delay Time	t _{d(on)}		-	7	-	nS			
Turn-on Rise Time	t _r	V _{DD} =-15V,I _D =-3.2A	-	3	-	nS			
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =6 Ω	-	30	-	nS			
Turn-Off Fall Time	t _f		-	12	-	nS			
Total Gate Charge	Qg		-	9.5	-	nC			
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-4A,V _{GS} =-4.5V	-	2	-	nC			
Gate-Drain Charge	Q_{gd}		-	3	-	nC			
Drain-Source Diode Characteristics									
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-1A	-	-	-1.2	V			

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2\%$.
- 4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

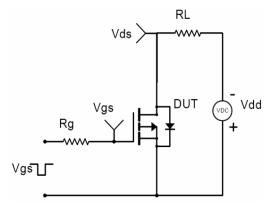
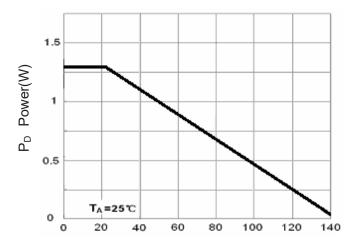
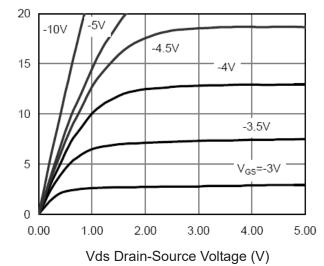


Figure 1:Switching Test Circuit



T_J-Junction Temperature(°C)

Figure 3 Power Dissipation



I_D- Drain Current (A)

Figure 5 Output Characteristics

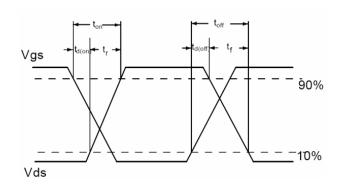


Figure 2:Switching Waveforms

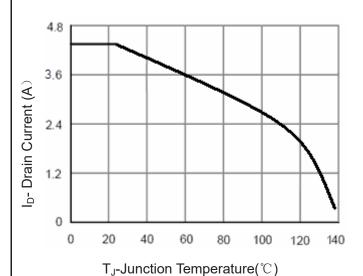


Figure 4 Drain Current

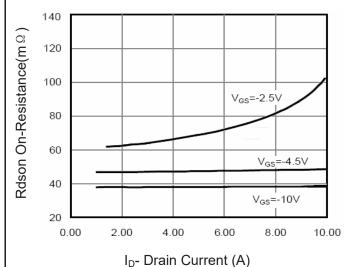


Figure 6 Drain-Source On-Resistance



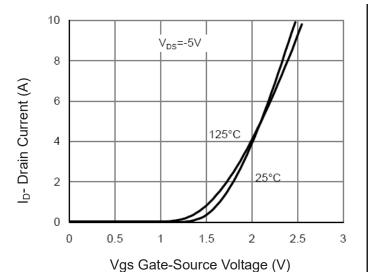
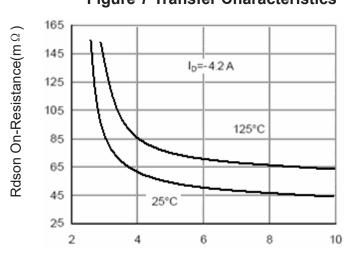


Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs

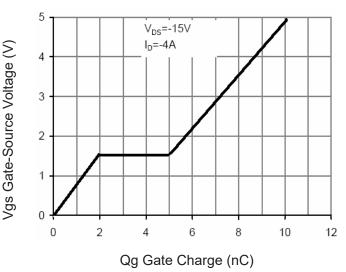
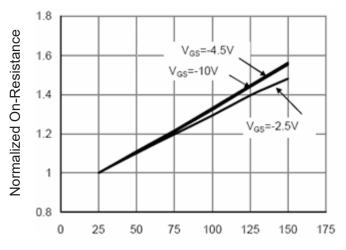
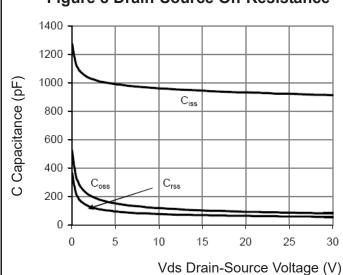


Figure 11 Gate Charge



 T_J -Junction Temperature($^{\circ}$ C) Figure 8 Drain-Source On-Resistance



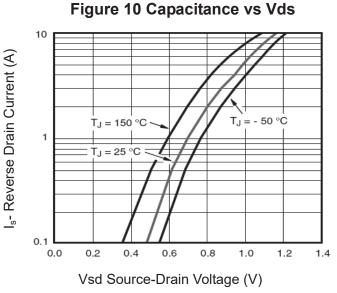


Figure 12 Source- Drain Diode Forward



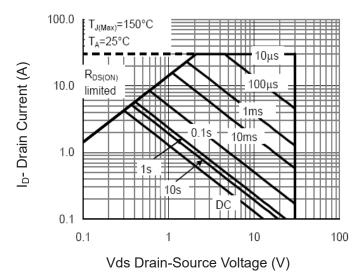


Figure 13 Safe Operation Area

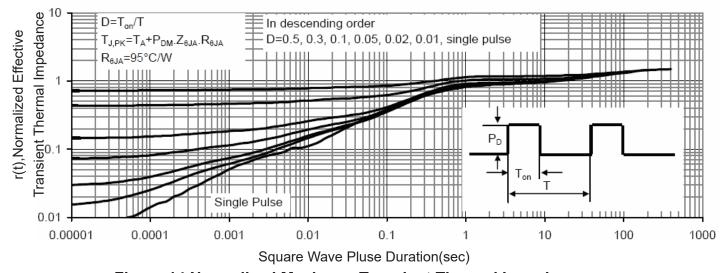


Figure 14 Normalized Maximum Transient Thermal Impedance